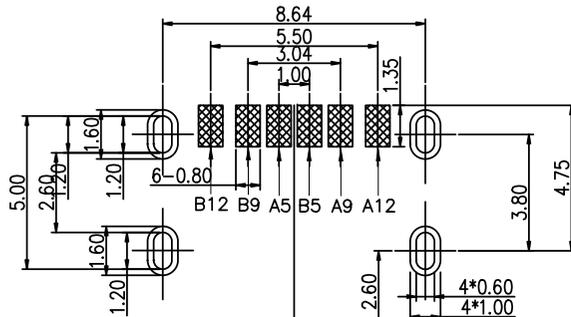
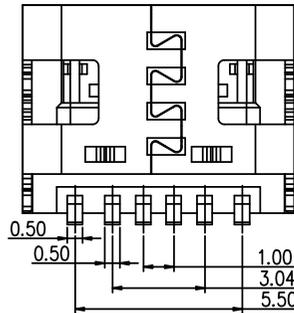
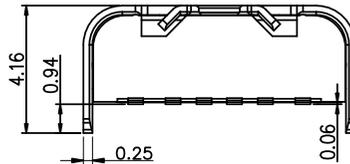
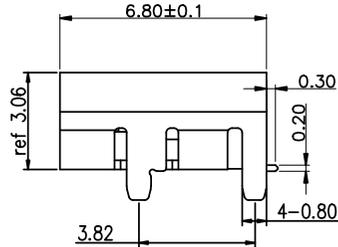
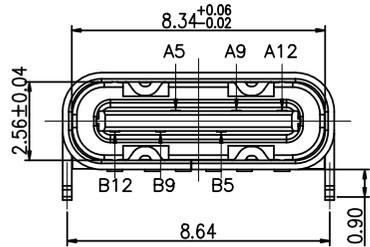
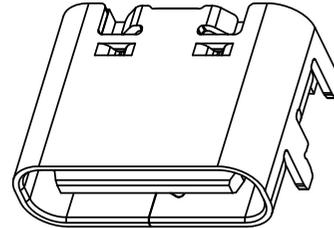
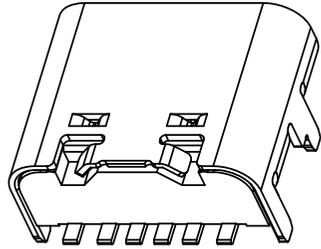
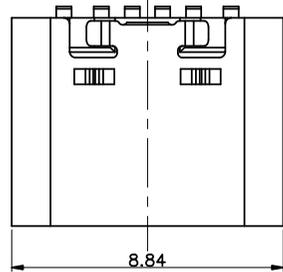


RoHS

目錄
MAPX

設變內容
MODIFICATION

日期
DATE



RECOMMENDED P.C.B. LAYOUT
TOLERANCE UNSPECIFIED ±0.05mm

NOTE:

1. MATERIAL SPECIFICATION:
 1. HOUSING: HIGH TEMPERATURE RESISTANT PLASTIC, UL94 V-0.
 2. CONTACTS: COPPER ALLOY
 3. MID PLATE: STAINLESS STEEL
 4. FRONT SHELL: STAINLESS STEEL
2. PLATING SPECIFICATION:
 - 2-1. CONTACTS:
 - Ni 30u" MIN. UNDER PLATED OVER ALL.
 - Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
 - (GOLD PLATING THICKNESS FOLLOW THE P/N)
 - PLATING SPECIFICATIONS OF THE SOLDER AREA FOLLOW THE P/N
 - 2-2. FRONT SHELL: SEE TABLE1.
 - 2-3. SHIELD PLATE&EMI PLATE: CLEAR ONLY
3. MECHANICAL PERFORMANCE,
 - 3-1. INSERTION FORCE: 0.5~2.0kgf.
 - 3-2. REMOVAL FORCE: 0.8kgf~2.0kgf.
 - 3-3. DURABILITY: 5000 CYCLES.
4. ELECTRICAL PERFORMANCE,
 - 4-1. CURRENT RATING: 3.0A
VOLTAGE RATING: 5.0V
 - 4-2. LLCR:
 - VBUS & GND PINS AND OTHER PINS: 40mΩ/PIN MAX.
 - SHIELD: 50mΩ/MAX.
 - LLCR MAX. CHANGE OF ALL PINS: 10mΩ.
 - 4-3. INSULATION RESISTANCE: 100MΩ MIN
 - 4-4. DIELECTRIC WITHSTAND VOLTAGE, AC 100V FOR 1 MINUTE.
5. ENVIRONMENTAL PERFORMANCE:
 - OPERATING TEMPERATURE: -25°C~+85°C.
6. IR REFLOW:
 - THE PEAK TEMPERATURE ON THE BOARD SHALL BE MAINTAINED FOR 10 SECONDS AT 260°C.

A5	CC1	B12	GND
A9	VBUS	B9	VBUS
		B5	CC2
		B01	GND
PIN	SIGNAL NAME	PIN	SIGNAL NAME

产品图 PRODUCT CHART DWG			
公差一览表 TOLERANCE UNLESS OTHERWISE			
X.	±0.35	X'.	±5'
.X	±0.30	.X'	±2'
.XX	±0.25	.XX'	±1'
.XXX	±0.10	.XXX'	±0.5'

		深圳市精拓金电子有限公司 Shenzhen Jing Tuo Jin Electronics Co., Ltd.						
		单位 UNITS	MM	制图 DRAWING	Erick	产品料号 PRODUCT PART NO.	918-418K2023S40086	
比例 SCALE		1:1	审核 CHKD	L S S	产品名称 PRODUCT NO.	TYPE-C3.1母座板上6.8四脚插板LCP黑胶SMT 6PIN		
日期 DATE		2021/03/10	核准 APPD	黄国荣	角法 VIEW	<table border="1"> <tr> <td>版本 VER</td> <td>A0</td> </tr> </table>	版本 VER	A0
版本 VER	A0							